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24-bit bus exchange switch with 12-bit output enables

Rev. 02 — 3 November 2008

Product data sheet

1. General description

The CBT16212 provides 24 bits of high-speed TTL-compatible bus switching or exchanging. The low ON resistance of the switch allows connections to be made with minimal propagation delay.

The CBT16212 operates either as a 24-bit bus switch or as a 12-bit bus exchanger, providing data exchange between four signal ports using the port select inputs (S0, S1 and S2).

The CBT16212 is characterized for operation from -40 °C to +85 °C.

2. Features

- 5 Ω switch connection between two ports
- TTL compatible input levels
- ESD protection:
 - HBM JESD22-A114E Class 1C exceeds 1500 V
 - CDM JESD22-C101C exceeds 1000 V
- Latch-up performance:
 - JESD78 exceeds 100 mA

3. Ordering information

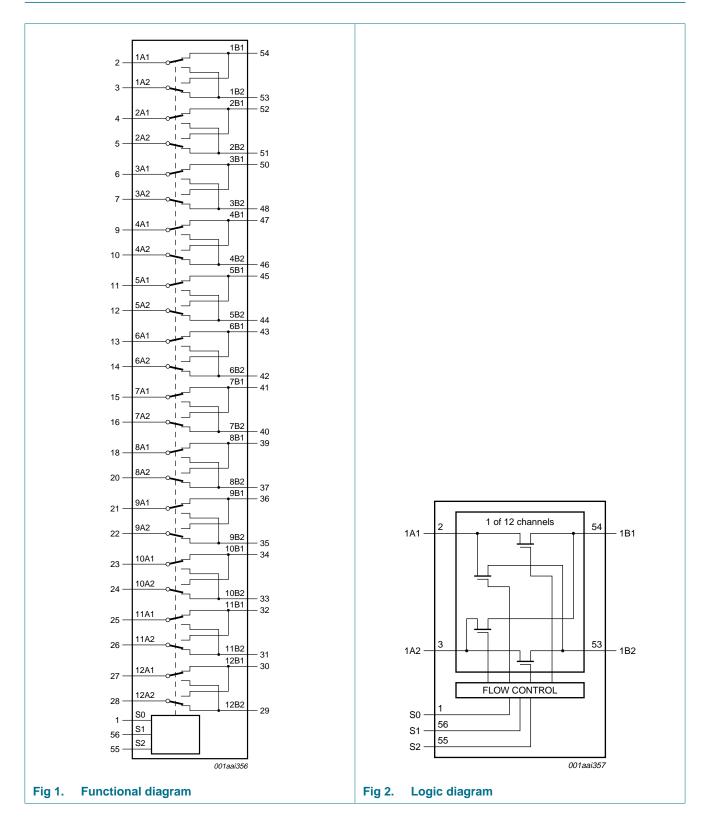
Table 1.	Ordering	information
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Type number	Package						
	Temperature range	Name	Description	Version			
CBT16212DGG	–40 °C to 85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1			
CBT16212DL	–40 °C to 85 °C	SSOP56	plastic shrink small outline package; 56 leads; body width 7.5 mm	SOT371-1			



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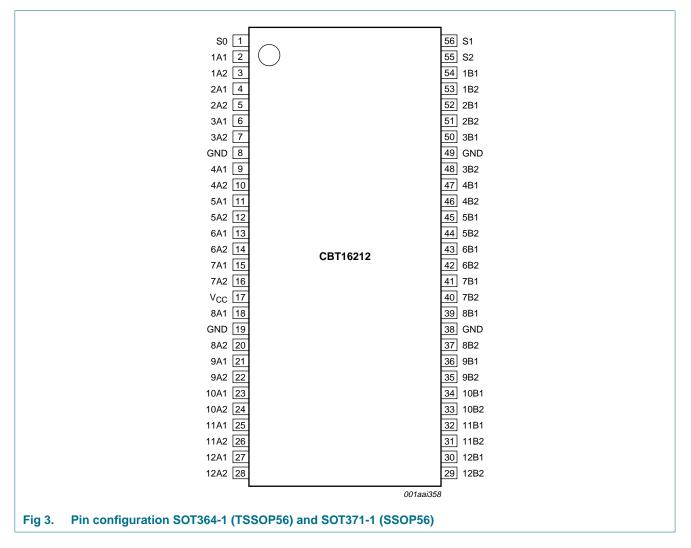
4. Functional diagram



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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin c	lescription	
Symbol	Pin	Description
S0, S1, S2	1, 56, 55	port select input
1A1 to 12A1	2, 4, 6, 9, 11, 13, 15, 18, 21, 23, 25, 27	A1 port
1A2 to 12A2	3, 5, 7, 10, 12, 14, 16, 20, 22, 24, 26, 28	A2 port
GND	8, 19, 38, 49	ground (0 V)
V _{CC}	17	supply voltage
1B1 to 12B1	54, 52, 50, 47, 45, 43, 41, 39, 36, 34, 32, 30	B1 port
1B2 to 12B2	53, 51, 48, 46, 44, 42, 40, 37, 35, 33, 31, 29	B2 port

CBT16212_2 Product data sheet 24-bit bus exchange switch with 12-bit output enables

6. Functional description

Table 3. Function selection^[1]

Port select input			Input/outpu	ut	Function
S2	S1	S0	nA1	nA2	
L	L	L	Z	Z	disconnect
L	L	Н	nB1	Z	nA1 = nB1
L	Н	L	nB2	Z	nA1 = nB2
L	Н	Н	Z	nB1	nA2 = nB1
Н	L	L	Z	nB2	nA2 = nB2
Н	L	Н	Z	Z	disconnect
Н	Н	L	nB1	nB2	nA1 = nB1 and nA2 = nB2
Н	Н	Н	nB2	nB1	nA1 = nB2 and $nA2 = nB1$

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		<u>[1]</u> –0.5	+7.0	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
Vo	output voltage	output at HIGH level or OFF-state	-0.5	+5.5	V
lo	output current	output at LOW level	-	128	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$			
		SSOP56 package	<u>[3]</u> _	850	mW
		TSSOP56 package	<u>[4]</u> _	600	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.

[3] Above 55 °C the value of P_{tot} derates linearly with 11.3 mW/K.

[4] Above 55 °C the value of P_{tot} derates linearly with 8 mW/K.

8. Recommended operating conditions

Table 5.Operating conditions

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

Symbol	Parameter	Conditions	Min	Max	Unit
Oymbol	Tarameter	Conditions	NVIII I	Max	Onit
V _{CC}	supply voltage		4.0	5.5	V
V _{IH}	HIGH-level input voltage		2.0	-	V
V _{IL}	LOW-level input voltage		-	0.8	V
T _{amb}	ambient temperature	operating in free-air	-40	+85	°C
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9. Static characteristics

Table 6. Static characteristics

Tamb	$= -40 \circ C$ to $+85 \circ C$.	
------	------------------------------------	--

Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Max	Unit
V _{IK}	input clamping voltage	$V_{CC} = 4.5 \text{ V}; \text{ I}_{\text{I}} = -18 \text{ mA}$		-	-	-1.2	V
l _l	input leakage current	$V_{CC} = 0 \text{ V}; \text{ V}_{I} = 5.5 \text{ V}$		-	-	10	μΑ
		V_{CC} = 5.5 V; V_I = V_{CC} or GND		-	-	±1	μΑ
I _{CC}	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 5.5 \ V; \ I_{O} = 0 \ A; \\ V_{I} = V_{CC} \ \text{or GND} \end{array}$		-	-	3	μA
ΔI_{CC}	additional supply current	per port select input pin; V _{CC} = 5.5 V; one input at 3.4 V, other inputs at V _{CC} or GND	[2]	-	-	2.5	mA
CI	input capacitance	port select input pins; V ₁ = 3 V or 0 V; $V_{CC} = 5.0$ V;		-	4.7	-	pF
C _{io(off)}	off-state input/output capacitance	$V_{O} = 3 V \text{ or } 0 V; V_{CC} = 0 V$		-	11.5	-	pF
R _{ON}	ON resistance	$V_{CC} = 4.0 V$	[3]				
		V _I = 2.4 V; I _I = 15 mA		-	-	21	Ω
		$V_{CC} = 4.5 V$	[3]				
		$V_{I} = 0 V; I_{I} = 64 mA$		-	4	7	Ω
		V _I = 0 V; I _I = 30 mA		-	4	7	Ω
		V _I = 2.4 V; I _I = 15 mA		-	6	12	Ω

[1] All typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

[3] Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. ON resistance is determined by the lowest voltage of the two (A or B) terminals.

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $T_{amb} = -40 \circ C$ to +85 $\circ C$; $V_{CC} = 4.5 \vee to 5.5 \vee to 5.5$

Symbol	Parameter	Conditions		Min	Max	Unit
t _{pd}	propagation delay	input A or B to output B or A; see Figure 4	[1][2]	-	0.25	ns
t _{en}	enable time	port select input to output A or B; Figure 5	[3]	2.4	8.0	ns
t _{dis}	disable time	port select input to output A or B; Figure 5	[4]	2.4	8.0	ns

[1] This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical ON resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

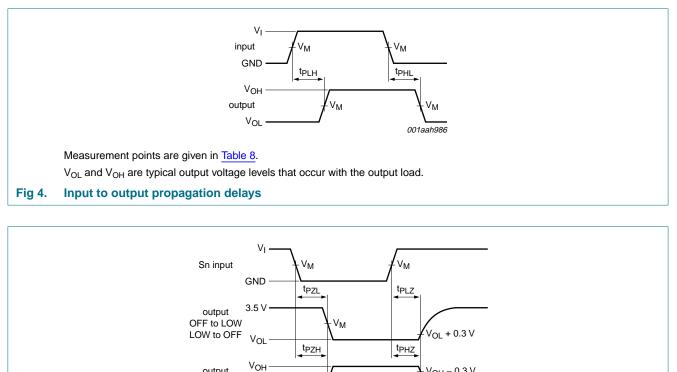
[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] t_{en} is the same as t_{PZL} and t_{PZH} .

[4] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

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11. Waveforms



 $V_{OH} = V_{OH} = V_{V} + V_{V} + V_{OH} = 0.3 V$ $V_{OH} = 0.3 V$ V_{O

Table 8.Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	V _M
4.5 V to 5.5 V	1.5 V	1.5 V

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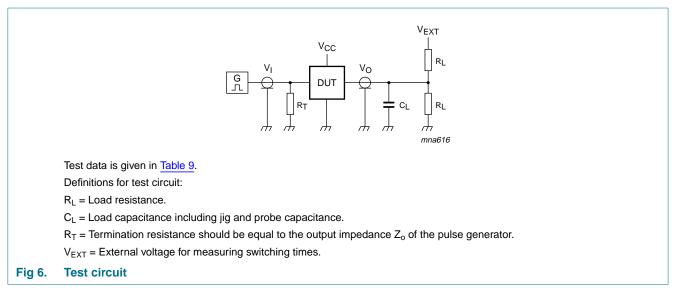


Table 9. Test data

Supply voltage	Input	Load		V _{EXT}			
V _{CC}	Vi	$\mathbf{t}_{r} = \mathbf{t}_{f}$	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
4.5 V to 5.5 V	GND to 3.0 V	≤ 2.5 ns	50 pF	500 Ω	open	open	7.0 V

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12. Package outline

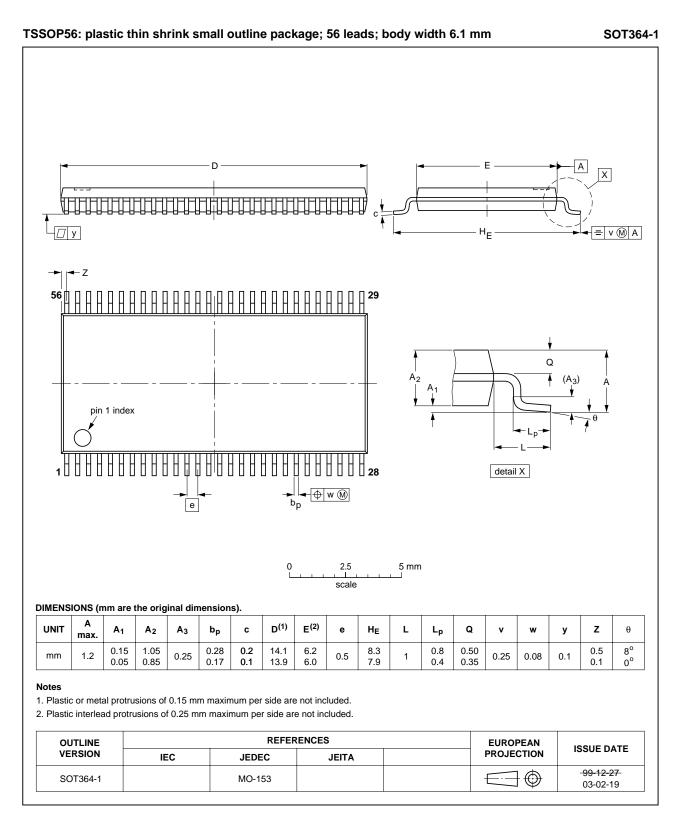


Fig 7. Package outline SOT364-1 (TSSOP56)

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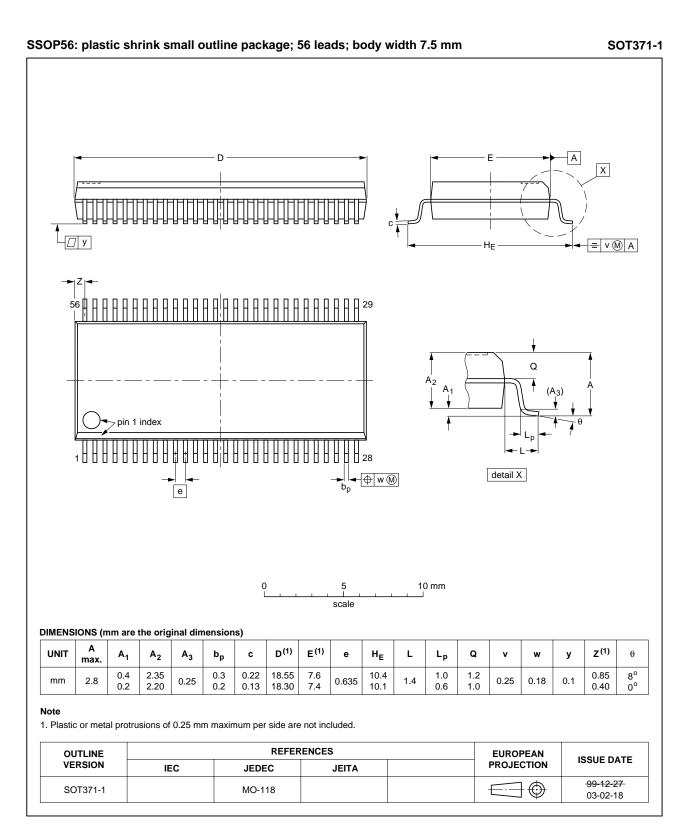


Fig 8. Package outline SOT371-1 (SSOP56)

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13. Abbreviations

Table 10. Abbi	reviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
CBT16212_2	03112008	Product data sheet	-	CBT16212_1		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 					
	<u>Table 7 "Dynamic characteristics"</u> :					
	 Enable time: min value changed from 3.6 into 2.4. Disable time: min value changed from 4.5 into 2.4. 					
	- Disable t	ime: min value changed inc	om 4.5 into 2.4.			
CBT16212_1	20010928	Product data	-	-		

15. Legal information

15.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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